

200mA, 35V Schottky Barrier Diode

FEATURES

- Designed for mounting on small surface
- Low Capacitance
- Low forward voltage drop
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Adapters
- For switching power supply
- Low stored charge
- Inverter

MECHANICAL DATA

- Case:0603
- Molding compound meets UL 94 V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Matte Au plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: Indicated by cathode band
- Weight: 3 mg (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$I_{F(AV)}$	200	mA
V_{RRM}	35	V
I_{FSM}	1.0	A
V_F at $I_F=200mA$	0.6	V
T_{JMAX}	125	°C
Package	0603	
Configuration	Single dice	



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	TSS0230U	UNIT
Marking code on the device		BB	
Repetitive peak reverse voltage	V_{RRM}	35	V
Forward current	$I_{F(AV)}$	200	mA
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed on Rate Load	I_{FSM}	1	A
Junction temperature range	T_J	-40 to +125	°C
Storage temperature range	T_{STG}	-40 to +125	°C

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾	$I_F = 200\text{mA}$, $T_J = 25^\circ\text{C}$	V_F	-	0.6	V
Reverse current @ rated V_R per diode ⁽²⁾	$V_R = 10\text{V}$ $T_J = 25^\circ\text{C}$	I_R	-	1	μA
Junction capacitance	1 MHz, $V_R = 1\text{V}$	C_J	-	18	pF

Notes:

1. Pulse test with $PW = 0.3\text{ ms}$
2. Pulse test with $PW = 30\text{ ms}$

ORDERING INFORMATION				
PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
TSS0230U (Note 1)	RG	G	0603	4K / 7" Reel

Notes:

1. Whole series with green compound

EXAMPLE				
EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
TSS0230U RGG	TSS0230U	RG	G	Green compound

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Characteristics

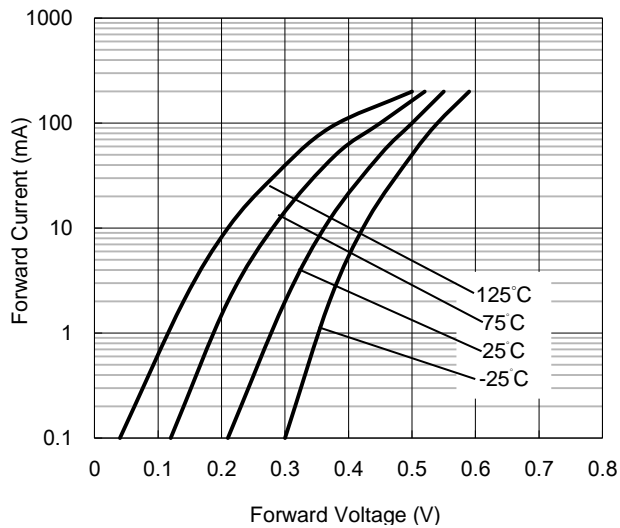


Fig.2 Reverse characteristics

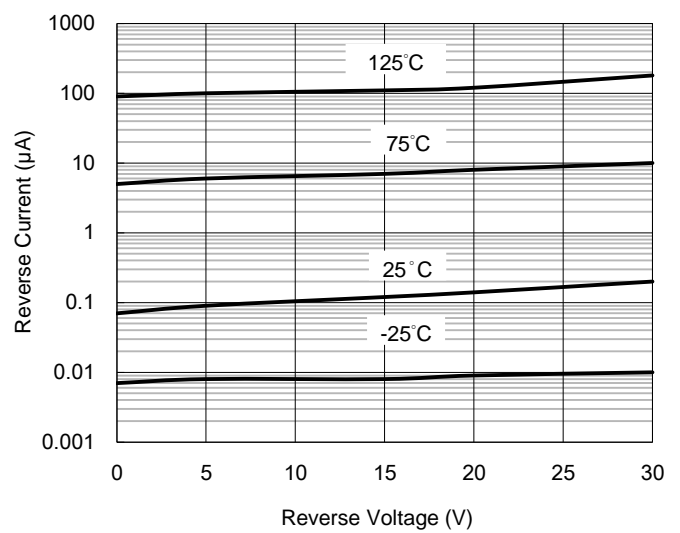


Fig.3 Capacitance between terminals characteristics

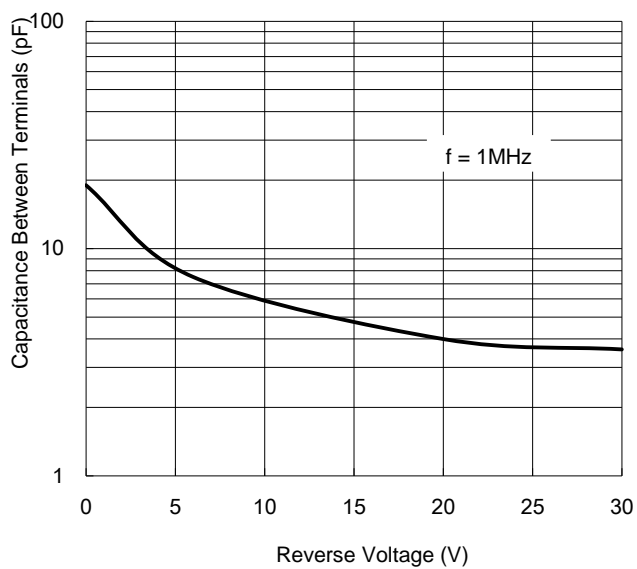
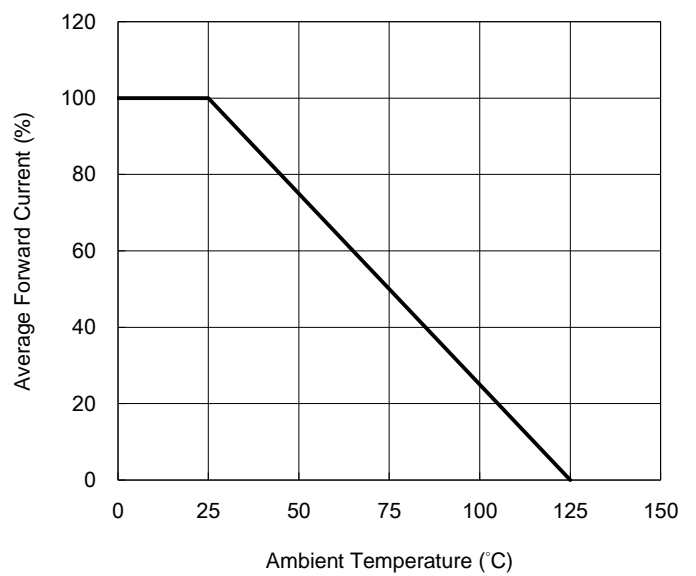


Fig.4 Current derating curve



CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.5 VF Dispersion Map

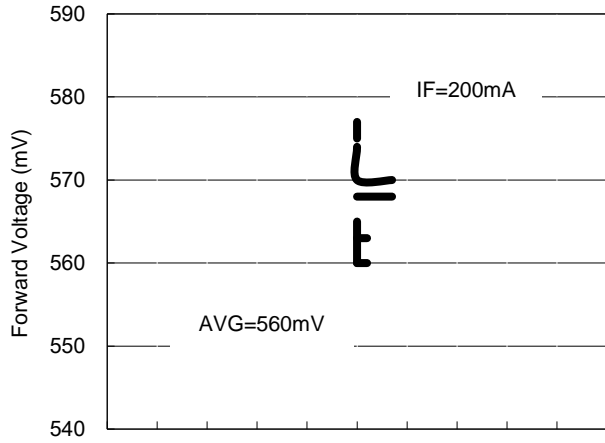


Fig.6 IR Dispersion Map

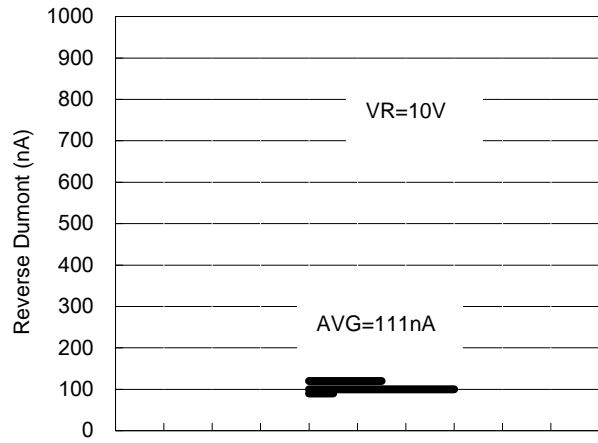
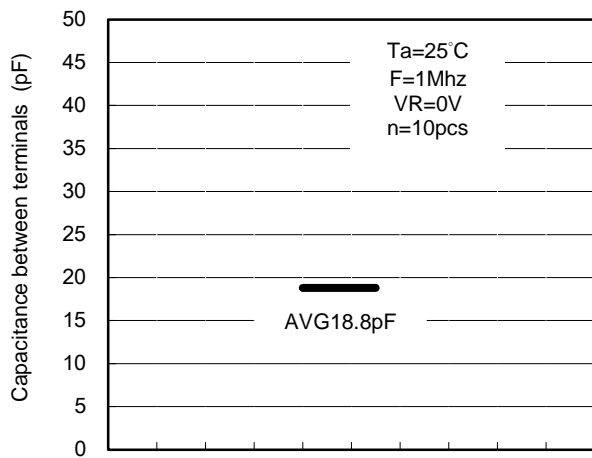
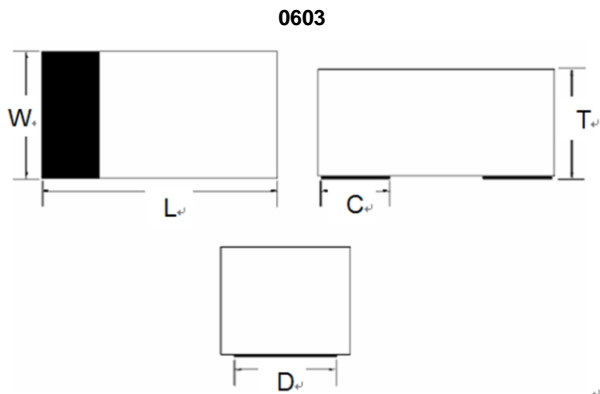


Fig.7 CT Dispersion Map



PACKAGE OUTLINE DIMENSION



DIM.	Unit(mm)			Unit(inch)		
	Min	Typ	Max	Min	Typ	Max
L	1.60	-	1.80	0.063	-	0.071
W	0.80	-	1.00	0.031	-	0.039
T	0.70	-	0.85	0.028	-	0.033
C	-	0.45	-	-	0.018	-
D	-	0.70	-	-	0.028	-

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